

Surface Mount Superfast Recovery Rectifier

FEATURES:

- For surface mounted applications
- Low profile package
- Glass Passivated Chip Junction
- Superfast reverse recovery time
- Lead free in comply with EU RoHS 2011/65/EU directives

Circuit Diagram & Pin Configuration:



SMBF

Absolute Maximum Ratings and Characteristics

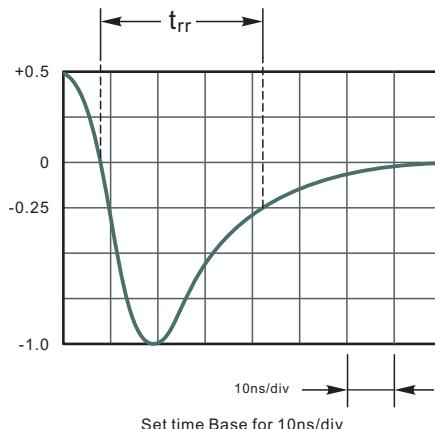
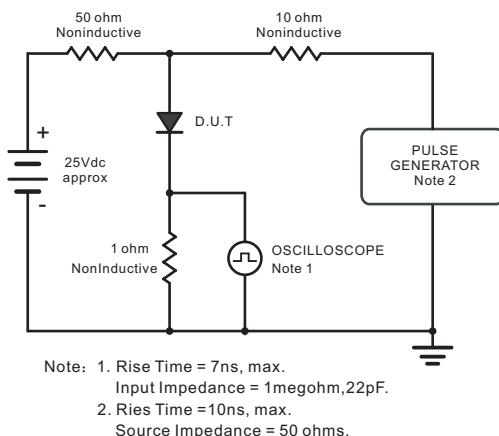
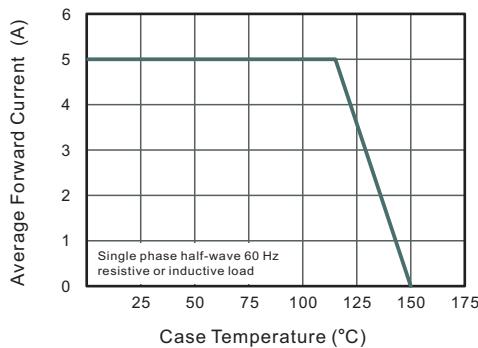
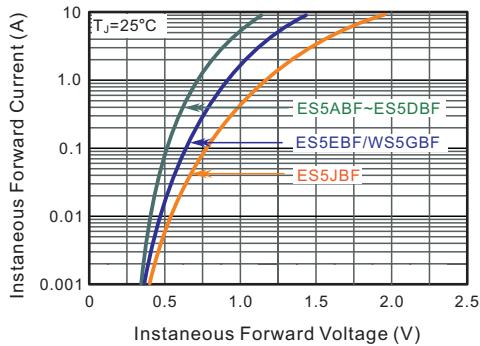
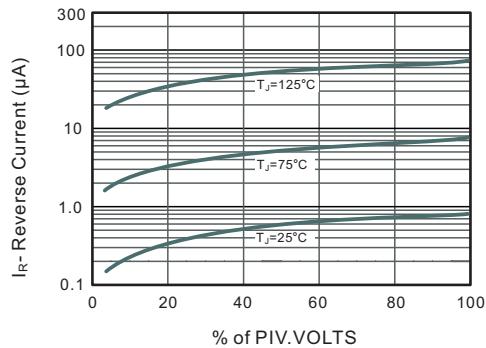
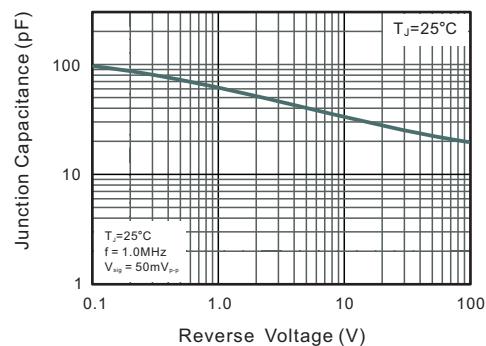
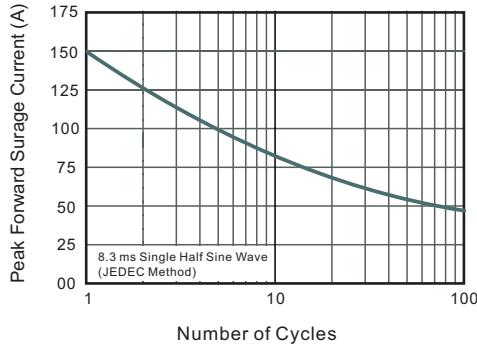
Ratings at 25 °C ambient temperature unless otherwise specified. Single phase, half wave, 60 Hz, resistive or inductive load. For capacitive load, derate current by 20%.

Type number	Marking code
ES5ABF	E5AB
ES5BBF	E5BB
ES5CBF	E5CB
ES5DBF	E5DB
ES5EBF	E5EB
ES5GBF	E5GB
ES5JBF	E5JB

Parameter	Symbols	ES5ABF	ES5BBF	ES5CBF	ES5DBF	ES5EBF	ES5GBF	ES5JBF	Units		
Maximum Repetitive Peak Reverse Voltage	V_{RRM}	50	100	150	200	300	400	600	V		
Maximum RMS voltage	V_{RMS}	35	70	105	140	210	280	420	V		
Maximum DC Blocking Voltage	V_{DC}	50	100	150	200	300	400	600	V		
Maximum Average Forward Rectified Current at $T_c = 115^\circ\text{C}$	$I_{F(AV)}$	5							A		
Peak Forward Surge Current 8.3 ms Single Half Sine Wave Superimposed on Rated Load	I_{FSM}	150							A		
Maximum Forward Voltage at 5A	V_F	1.0			1.25		1.7	V			
Maximum DC Reverse Current $T_a = 25^\circ\text{C}$ at Rated DC Blocking Voltage $T_a = 125^\circ\text{C}$	I_R	10 100							μA		
Typical Junction Capacitance at $V_R=4\text{V}$, $f=1\text{MHz}$	C_j	50							pF		
Maximum Reverse Recovery Time ⁽¹⁾	t_{rr}	35							ns		
Typical Thermal Resistance ⁽²⁾	$R_{\theta JA}$ $R_{\theta JC}$	40 12							$^\circ\text{C}/\text{W}$		
Operating and Storage Temperature Range	T_j , T_{stg}	-55 ~ +150							$^\circ\text{C}$		

(1) Measured with $I_F = 0.5 \text{ A}$, $I_R = 1 \text{ A}$, $I_{rr} = 0.25 \text{ A}$.

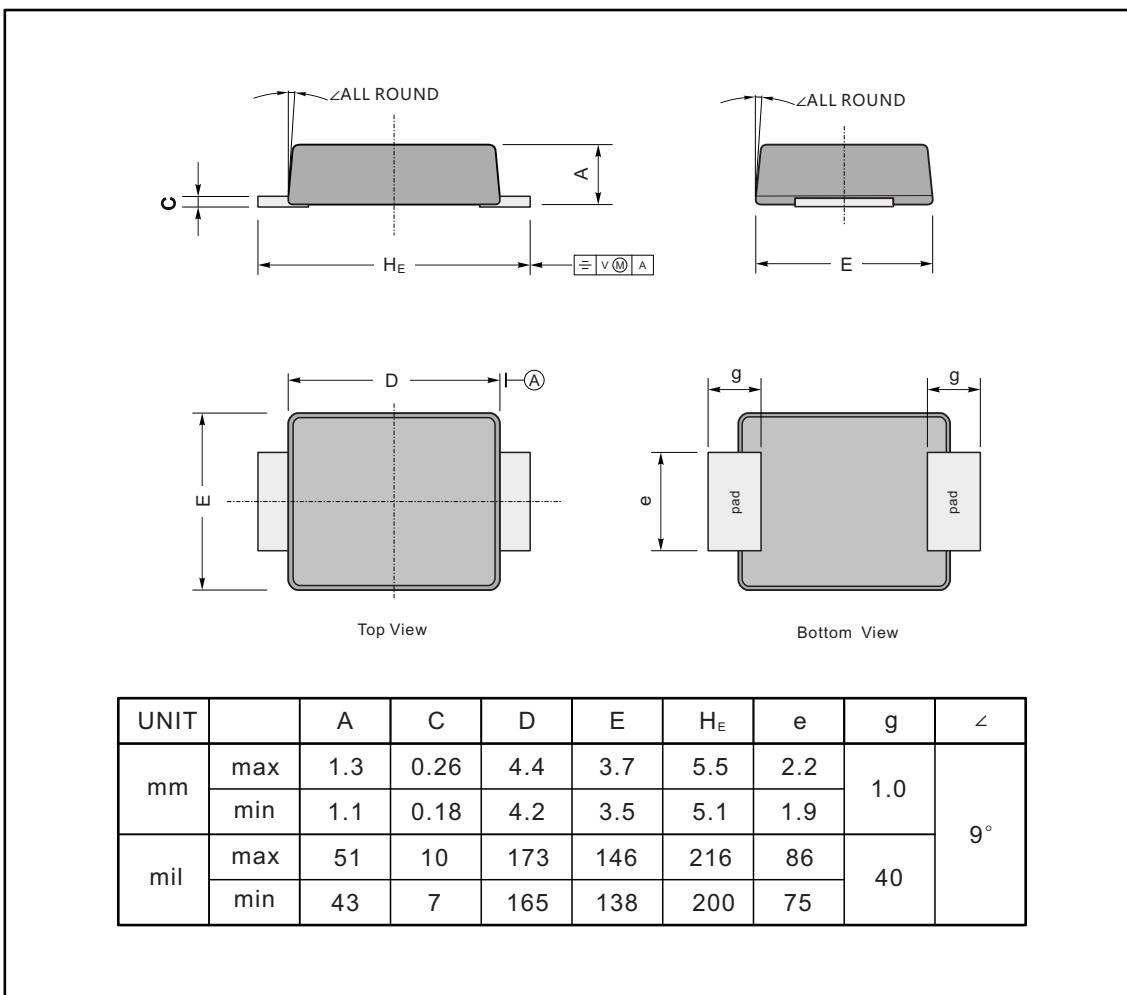
(2) P.C.B. mounted with 2.0" X 2.0" (5 X 5 cm) copper pad areas.

Fig.1 Reverse Recovery Time Characteristic And Test Circuit Diagram

Fig.2 Maximum Average Forward Current Rating

Fig.4 Typical Forward Characteristics

Fig.3 Typical Reverse Characteristics

Fig.5 Typical Junction Capacitance

Fig.6 Maximum Non-Repetitive Peak Forward Surge Current


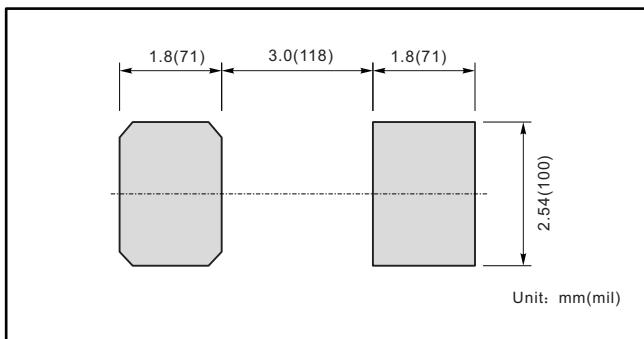
PACKAGE OUTLINE

Plastic surface mounted package; 2 leads

SMBF



The recommended mounting pad size



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